

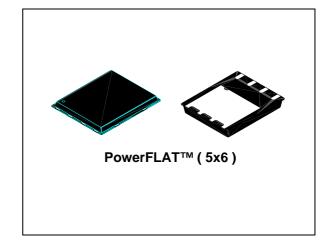
## STL60N3LLH5

## N-channel 30 V, 0.0063 Ω, 17 A PowerFLAT™ (5x6) STripFET™ V Power MOSFET

#### **Features**

Туре	V <sub>DSS</sub>	R <sub>DS(on)</sub> max	I <sub>D</sub>
STL60N3LLH5	30 V	<0.0071 Ω	17 A <sup>(1)</sup>

- 1. The value is rated according  $R_{thj\text{-pcb}}$
- $\blacksquare$  R<sub>DS(on)</sub> \* Q<sub>g</sub> industry benchmark
- Extremely low on-resistance R<sub>DS(on)</sub>
- Very low switching gate charge
- High avalanche ruggedness
- Low gate drive power losses



#### **Application**

Switching applications

#### **Description**

This STripFET<sup>TM</sup>V Power MOSFET technology is among the latest improvements, which have been especially tailored to achieve very low on-state resistance providing also one of the best-in-class figure of merit (FOM).

Figure 1. Internal schematic diagram

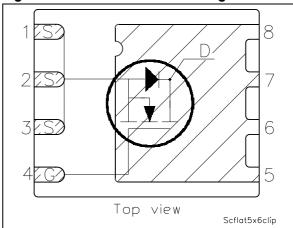


Table 1. Device summary

Order code	Marking	Package	Packaging
STL60N3LLH5	60N3LLH5	PowerFLAT™ (5x6)	Tape and reel

Contents STL60N3LLH5

## **Contents**

1	Electrical ratings	3
2	Electrical characteristics	4
	2.1 Electrical characteristics (curves)	6
3	Test circuits	8
4	Package mechanical data	9
5	Revision history	. 11

STL60N3LLH5 Electrical ratings

# 1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage (V <sub>GS</sub> = 0)	30	V
V <sub>GS</sub>	Gate-source voltage	± 22	٧
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 25 °C	60	Α
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 100 °C	37.5	Α
I <sub>D</sub> <sup>(2)</sup>	Drain current (continuous) at T <sub>C</sub> = 25 °C	17	Α
I <sub>D</sub> <sup>(2)</sup>	Drain current (continuous) at T <sub>C</sub> =100°C	10.6	Α
I <sub>DM</sub> <sup>(3)</sup>	Drain current (pulsed)	68	Α
P <sub>TOT</sub> <sup>(1)</sup>	Total dissipation at T <sub>C</sub> = 25°C	60	W
P <sub>TOT</sub> <sup>(2)</sup>	Total dissipation at T <sub>C</sub> = 25°C	4	W
	Derating factor	0.03	W/°C
T <sub>J</sub> T <sub>stg</sub>	Operating junction temperature Storage temperature	-55 to 150	°C

<sup>1.</sup> The value is rated according  $R_{\text{thj-c}}$ 

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case (Drain) (steady state)	2.08	°C/W
R <sub>thj-pcb</sub> (1)	Thermal resistance junction-ambient	31.3	°C/W

<sup>1.</sup> When mounted on FR-4 board of 1inch², 2oz Cu, t < 10 sec

Table 4. Avalanche data

Symbol	Parameter	Value	Unit
I <sub>AV</sub>	Not-repetitive avalanche current (pulse width limited by Tj Max)	12.5	Α
E <sub>AS</sub>	Single pulse avalanche energy (starting $T_J = 25$ °C, $I_D = I_{AV}$ , $V_{DD} = 21$ V)	120	mJ

<sup>2.</sup> The value is rated according  $R_{\mbox{\scriptsize thj-pcb}}$ 

<sup>3.</sup> Pulse width limited by safe operating area

Electrical characteristics STL60N3LLH5

## 2 Electrical characteristics

(T<sub>CASE</sub> = 25°C unless otherwise specified)

Table 5. On/off states

Symbol	Parameter Test conditions		Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$I_D = 250 \text{ uA}$ . $V_{CC} = 0$				٧
I <sub>DSS</sub>	Zero gate voltage drain current (V <sub>GS</sub> = 0)	$V_{DS}$ = max rating, $V_{DS}$ = max rating @125 °C			1 10	μA μA
I <sub>GSS</sub>	Gate body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ± 22 V			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1			V
R <sub>DS(on)</sub>	Static drain-source on resistance	$V_{GS}$ = 10 V, $I_{D}$ = 8.5 A $V_{GS}$ = 4.5 V, $I_{D}$ = 8.5 A		0.0063 0.0086	0.0071 0.0095	Ω

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input capacitance Output capacitance Reverse transfer capacitance	V <sub>DS</sub> =25 V, f=1 MHz, V <sub>GS</sub> =0	-	1290 240 32	-	pF pF pF
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Total gate charge Gate-source charge Gate-drain charge	$V_{DD}$ =15 V, $I_D$ = 17 A $V_{GS}$ =4.5 V (see Figure 14)	-	8 3.6 3.4	-	nC nC nC

Table 7. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$\begin{array}{c} t_{d(on)} \\ t_{r} \\ t_{d(off)} \\ t_{f} \end{array}$	Turn-on delay time Rise time Turn-off delay time Fall time	$V_{DD}$ =15 V, $I_{D}$ = 8.5 A, $R_{G}$ =4.7 $\Omega$ , $V_{GS}$ =10 V (see Figure 13)	-	8.6 11.2 32.4 6	-	ns ns ns

Table 8. Source drain diode

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I <sub>SD</sub>	Source-drain current		-		17	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		68	Α
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	I <sub>SD</sub> = 17 A, V <sub>GS</sub> =0	-		1.1	٧
t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 17 \text{ A},$ $di/dt = 100 \text{ A/}\mu\text{s},$ $V_{DD} = 25 \text{ V}, \text{ Tj} = 150 \text{ °C}$	-	22 15 1.4		ns nC A

<sup>1.</sup> Pulse width limited by safe operating area

<sup>2.</sup> Pulsed: pulse duration= 300  $\mu$ s, duty cycle 1.5%

Electrical characteristics STL60N3LLH5

#### 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance

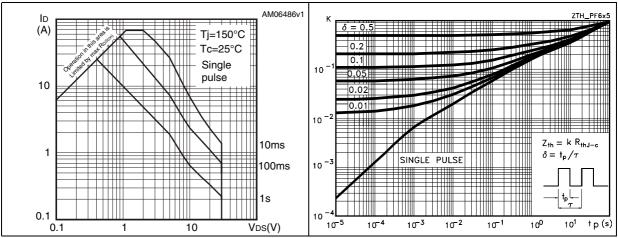


Figure 4. Output characteristics

Figure 5. Transfer characteristics

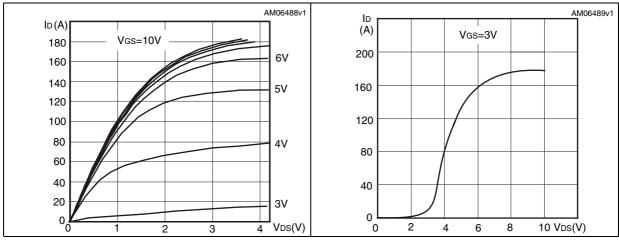
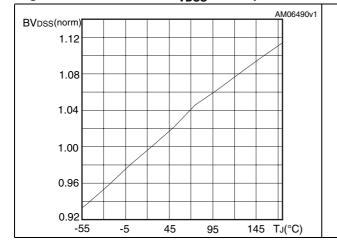
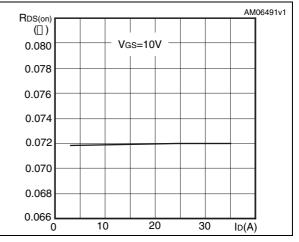


Figure 6. Normalized  $B_{VDSS}$  vs temperature Figure 7. Static drain-source on resistance





AM06492v1 AM06493v1 C (pF) Vgs (V) 12 VDD=15V 1600 ID=17A 10 1400 Ciss 1200 8 1000 800 600 400 Coss 200 Crss 0 12 Qg(nC) 4 6 8 10 10 20 V<sub>DS</sub>(V) 0

Figure 8. Gate charge vs gate-source voltage Figure 9. Capacitance variations

Figure 10. Normalized gate threshold voltage Figure 11. Normalized on resistance vs vs temperature temperature

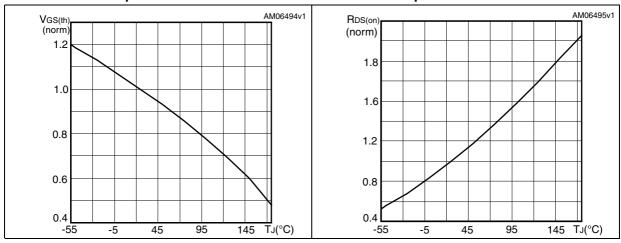
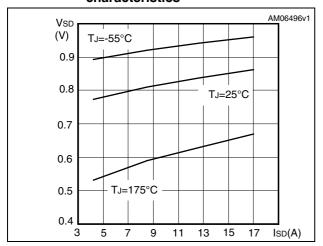


Figure 12. Source-drain diode forward characteristics



Test circuits STL60N3LLH5

### 3 Test circuits

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

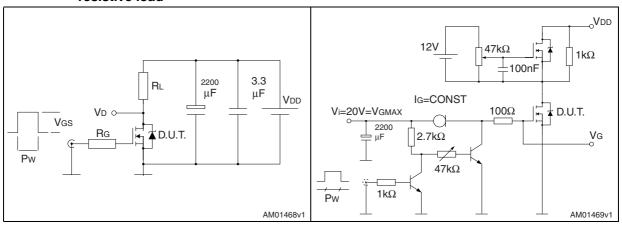


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped inductive load test circuit

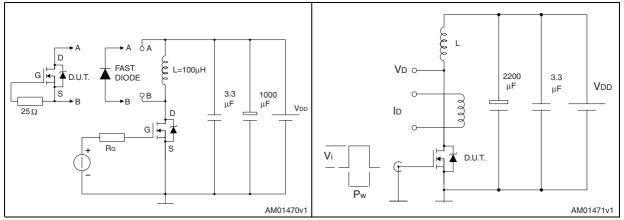
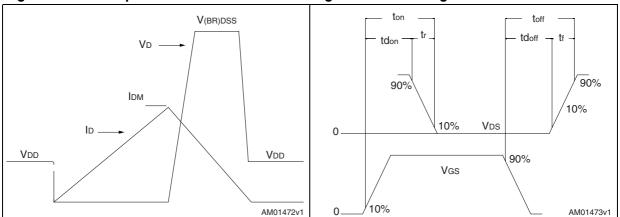


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform



577

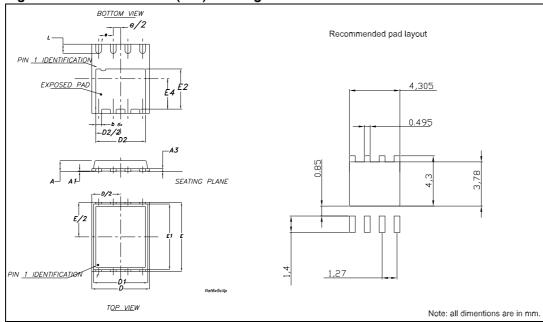
# 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Table 9. Power FLAT™ (5x6) mechanical data

Dim.		mm.			inch.	
Dilli.	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	0.80	0.83	0.93	0.031	0.32	0.036
A1		0.02	0.05		0.0007	0.0019
A3		0.20			0.007	
b	0.35	0.40	0.47	0.013	0.015	0.018
D		5.00			0.196	
D1		4.75			0.187	
D2	4.15	4.20	4.25	0.163	0.165	0.167
Е		6.00			0.236	
E1		5.75			0.226	
E2	3.43	3.48	3.53	0.135	0.137	0.139
E4	2.58	2.63	2.68		0.103	0.105
е		1.27			0.050	
L	0.70	0.80	0.90	0.027	0.031	0.035

Figure 19. Power FLAT™ (5x6) drawing



STL60N3LLH5 Revision history

# 5 Revision history

Table 10. Document revision history

Date	Revision	Changes
16-Mar-2010	1	First release

#### Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2010 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

12/12 Doc ID 17268 Rev 1